FOXCONN®

SPECIFICATIONS

DDRIV SO DIMM Socket

AS Series
9.2 mm Height
SMT Type
0.50mm Pitch
260 Pos.

Mechanical

Contact Retention Force: *0.10kg min.*
Durability : *60 Cycles*

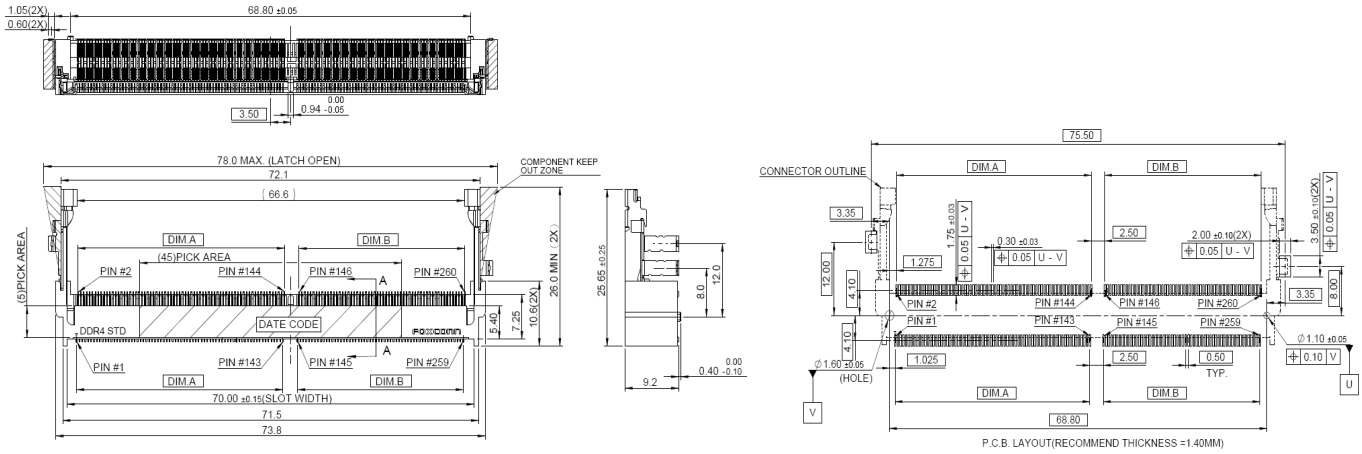
Electrical

Voltage Rating: *25V*
Current Rating: *0.5A*
Contact Resistance: *60mΩ max.*
Dielectric Withstanding Voltage: *250V AC/1 min.*
Insulation Resistance: *100MΩ*

Physical

Housing: *Thermoplastic, UL 94V-0 rated in Black Color*
Contact: *Copper alloy*
Plating: *See "ORDERING INFORMATION"*
Metal Spring: *Copper alloy*
Operating Temperature: *-55℃ to +85℃*

DRAWING



ORDERING INFORMATION

PRODUCT NO.: A S A A8 2 * - E A * B 0 - * H

- Memory Module Socket
- Horizontal Type
- Single Row
- No. Of Pos.
  A8=260 Pos.
- SMT Type
- Contact Area Plating
  1=Gold Flash
  Y=5u"Gold Plating
  6=10u"Gold Plating
  7=15u"Gold Plating
  3=30u"Gold Plating
- E=DDR SODIMM
- A=9.2mm Height
- S=Standard
  R=Reverse
- B=BLACK COLOR
- 0=Normal Type
- Package Code
  4=Soft Tray
  7=Tape Reel
- H=HALOGEN /LEAD FREE

P/ N	DIM.A	DIM.B
AS0A82*-EASB0- *H	35.50	28.50
AS0A82*-EARB0- *H	28.50	35.50

All specification & dimensions are subject to change, please call your nearest Foxconn sales representative for update information.